



1N4148WS SURFACE MOUNT FAST SWITCHING DIODE



Features

- High Conductance
- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- Small Package
- For General Purpose Switching Application
- This is a Halogen Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Schematic & Pin Configuration



Mechanical Characteristics

- Case: SOD-323, Molded plastic
- Terminals: Plated Leads Solderable per MIL-STD-202,
- Method 208
- Polarity: Cathode Band
- Weight: 0.04 grams(approx)

Maximum Ratings @TA=25°C unless otherwise specified

Characteristic	Symbol	Limits	Unit
Non- Repetitive Peak Reverse Voltage	V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	75	V
RMS Reverse Voltage	V _{R(RMS)}	53	V
Forward Continuous Current(Note 1)	l _F	300	mA
Average Rectified Output Current(Note 1)	lo	150	mA
Non-Repetitive Peak Forward Surge Current @t=1.0us @t=1.0s	I _{FSM}	2.0 1.0	А
Power Dissipation(Note 1)	P _D	200	mW
Typical Thermal Resistance, Junction to Ambient(Note 1)	R _{θJA}	625	°C/W
Junction and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Note: 1. Valid provided that terminals are kept at ambient temperature.



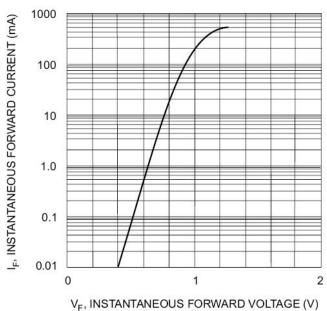


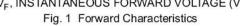
Electrical Characteristics @TA=25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Units	Test Condition
Forward Voltage*	V _{FM}	-	0.715 0.855 1.0 1.25	V	@I _F =1.0mA @I _F =10mA @I _F =50mA @I _F =150mA
Reverse Leakage Current*	I _{RM}	-	2.5	uA	@V _R =75V
Capacitance	Ст	-	2	pF	V _R =0V, f=1.0MHz
Reverse Recovery Time	t _{rr}	-	4	ns	$I_F=I_R=10$ mA $I_{rr}=0.1$ X I_R , $R_L=100$ Ω

^{*} Pulse width < 300 µs, duty cycle < 2%

Ratings and Characteristics Curves





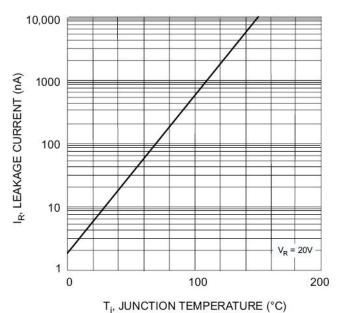


Fig. 2 Leakage Current vs Junction Temperature





Ordering Information

Device	Package	Shipping
1N4148WS	SOD-323	3000pcs / reel
1N4148WSTR	SOD-323	3000pcs / reel

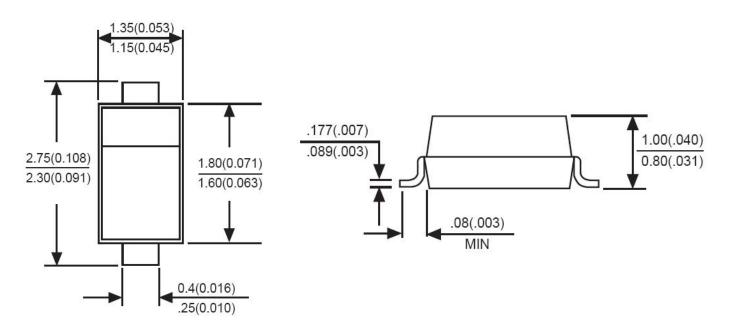
For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram

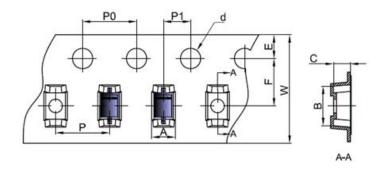


T4 = Marking Code

Mechanical Dimensions SOD-323(Inches/Millimeters)



Carrier Tape Specification SOD-323



SYMB	Millimeters		
OL	Min.	Max.	
В	2.85	2.95	
С	1.20	1.30	
d	1.40	1.60	
Е	1.65	1.85	
F	3.40	3.60	
Р	3.90	4.10	
P0	3.90	4.10	
P1	1.90	2.10	
W	7.90	8.30	

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